To our customers,

Old Company Name in Catalogs and Other Documents

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Renesas Electronics website: http://www.renesas.com

April 1st, 2010
Renesas Electronics Corporation

Issued by: Renesas Electronics Corporation (http://www.renesas.com)

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RENESAS

BIPOLAR ANALOG INTEGRATED CIRCUIT

Phase-out/Discontinued

μPC3018, 3025

LOW-SATURATION STABILIZED POWER SUPPLY WITH ON/OFF FUNCTION (1 A OUTPUT)

DESCRIPTION

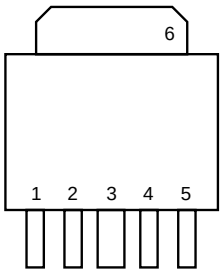
The μPC3018 and 3025 are low-saturation type regulators with an output current of 1 A at respective output voltages of 1.8 and 2.5 V. These regulators are also provided with an ON/OFF function, which reduces the dissipation when there is no load, making them ideal for systems requiring low power consumption.

FEATURES

- ON/OFF pin for output control (active-high)
- Output current capacitance: 1 A
- Low minimum voltage difference between input and output
  (V_{DIF} = 0.5 V MAX. (when I_O = 0.5 A))
- Output voltage accuracy: ±2%
- On-chip inrush current protection circuit for when input voltage rises (when input voltage is low)
- On-chip overcurrent limiter and thermal shutdown circuit
- On-chip safe operating area controller

PIN CONFIGURATION (Marking Side)

MP-3Z (5 pin), MP-3 (5 pin)



1: ON/OFF
2: INPUT
3: GND
4: OUTPUT
5: NC
6: GND (Fin)

ORDERING INFORMATION

Part Number	Package	Marking	Packing Type
μPC30xxTJ	MP-3Z (5 pin)	30xx	• In bags
μPC30xxTJ-E1	MP-3Z (5 pin)	30xx	• 16 mm embossed taping • Pin 1 in tape pull-out direction • 2000/reel
μPC30xxTJ-E2	MP-3Z (5 pin)	30xx	• 16 mm embossed taping • Pin 1 in tape wind-up direction • 2000/reel
μPC30xxHB	MP-3 (5 pin)	30xx	• In bags

"xx" in the part number and marking corresponds to the following output voltage.

Example

Output Voltage	Part Number	Marking
1.8 V	μPC3018TJ	3018
2.5 V	μPC3025TJ	3025

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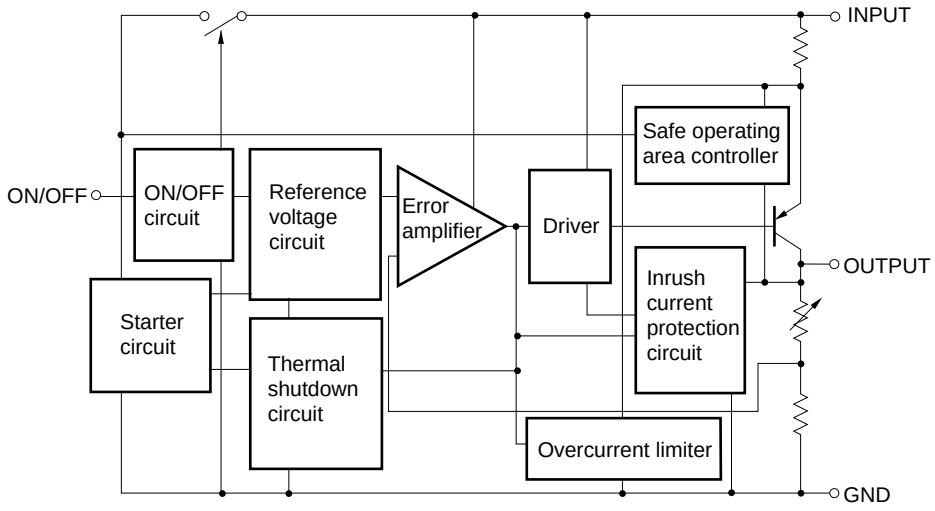
Printed in Japan

The mark ★ shows major revised points.

BLOCK DIAGRAM



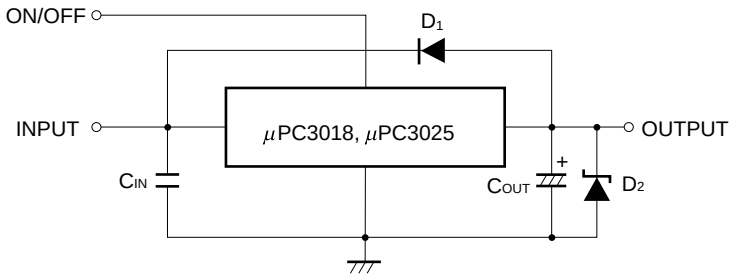
ABSOLUTE MAXIMUM RATINGS (T_A = 25°C unless otherwise specified)

Parameter	Symbol	Rating	Unit
Input Voltage	V_{IN}	–0.3 to +20	V
ON/OFF pin voltage	$V_{ON/OFF}$	–0.3 to V_{IN} +0.3 V (however, $V_{ON/OFF} \leq 20$)	
Internal Power Dissipation (T_C = 25°C)	P_T	10[Note]	W
Operating Ambient Temperature	T_A	–30 to +85	°C
Operating Junction Temperature	T_J	–30 to +150	°C
Storage Temperature	T_{stg}	–55 to +150	°C
Thermal Resistance (junction to case)	$R_{th(J-C)}$	12.5	°C/W
Thermal Resistance (junction to ambient)	$R_{th(J-A)}$	125	°C/W

Note The total dissipation is limited by an internal circuit. Where T_J > 150°C, an internal protection circuit cuts off the output.

Caution Product quality may suffer if the absolute maximum rating is exceeded even momentarily for any parameter. That is, the absolute maximum ratings are rated values at which the product is on the verge of suffering physical damage, and therefore the product must be used under conditions that ensure that the absolute maximum ratings are not exceeded.

TYPICAL CONNECTION



C_{IN}: Must be 0.1 μF or more. Determine the capacitance in accordance with the line between the power supply smoothing circuit and input pin. Be sure to connect this capacitor to prevent abnormal oscillation. Use of a capacitor with excellent voltage and temperature characteristics, such as a film capacitor, is recommended. Note that some laminated ceramic capacitors have poor temperature and voltage characteristics. When using a laminated ceramic capacitor, the capacitance of 0.1 μF or more must be reserved in the voltage and temperature ranges used.

C_{OUT}: Must be 10 μF or more. Be sure to connect this capacitor to prevent oscillation and to improve transient load stability.

Connect C_{IN} and C_{OUT} as close to the IC pins as possible (within 1 to 2 cm). Also, when using the device at 0°C or less, use an electrolytic capacitor with low impedance characteristics.

D_1: Connect a diode if the voltage on the OUTPUT pin is higher than that on the INPUT pin.

D_2: Connect a Schottky barrier diode if the voltage on the OUTPUT pin is lower than that on the GND pin.

Caution Ensure that voltage is not applied to the OUTPUT pin externally.
Supply V_{IN} and $V_{ON/OFF}$ from different power supplies.
Design so that V_{IN} and $V_{ON/OFF}$ either rise at the same time or $V_{ON/OFF}$ rises after V_{IN}.

RECOMMENDED OPERATING CONDITIONS

Parameter	Symbol	Corresponding Model	MIN.	TYP.	MAX.	Unit
Input Voltage	V_{IN}	μPC3018	2.8		16	V
		μPC3025	3.5		16	V
ON/OFF Pin Voltage	$V_{ON/OFF}$	All models	0		V_{IN}	
Output Current	I_O	All models	0		1	A
Operating Ambient Temperature	T_A	All models	−30		+85	°C
Operating Junction Temperature	T_J	All models	−30		+125	°C

Caution The recommended operating range may be exceeded without causing any problems provided the absolute maximum ratings are not exceeded. However, if the device is operated in a way that exceeds the recommended operating conditions, the margin between the actual conditions of use and the absolute maximum ratings is small, and therefore thorough evaluation is necessary.
The recommended operating conditions do not imply that the device can be used with all values at their maximum values.

ELECTRICAL CHARACTERISTICS

μPC3018 (T_J = 25°C, V_{IN} = 2.8 V, $V_{ON/OFF}$ = 2.8 V, I_O = 0.5 A, C_{IN} = 0.1 μF, C_{OUT} = 10 μF, unless otherwise specified)

Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Output Voltage	V_O		1.764	1.8	1.836	V
		0°C ≤ T_J ≤ 125°C, 2.8 V ≤ V_{IN} ≤ 5 V, 0 mA ≤ I_O ≤ 1 A	(1.71)		(1.854)	
Line Regulation	REG_{IN}	2.8 V ≤ V_{IN} ≤ 16 V		6	25	mV
Load Regulation	REG_L	0 A ≤ I_O ≤ 1 A		7	30	mV
Quiescent Current	I_{BIAS}	I_O = 0 A		2	4	mA
		I_O = 1 A		20	60	
Startup Quiescent Current	$I_{BIAS\ (s)}$	V_{IN} = 2.4 V, $V_{ON/OFF}$ = 2.0 V, I_O = 0 A		10	30	mA
		V_{IN} = 2.4 V, $V_{ON/OFF}$ = 2.0 V, I_O = 1 A			80	
Quiescent Current Change	ΔI_{BIAS}	0°C ≤ T_J ≤ 125°C, 2.8 V ≤ V_{IN} ≤ 16 V		2.9	20	mA
Output Noise Voltage	V_n	10 Hz ≤ f ≤ 100 kHz		40		$\mu V_{r.m.s.}$
Ripple Rejection	R•R	f = 120 Hz, 2.8 V ≤ V_{IN} ≤ 9 V	(45)	60		dB
Dropout Voltage	V_{DIF}	I_O = 0.5 A		0.25	0.5	V
		0°C ≤ T_J ≤ 125°C, I_O = 1 A		0.7		
Short Circuit Current	I_{Oshort}	V_{IN} = 2.8 V	1.2	1.7	3.0	A
		V_{IN} = 16 V		1.2		
Peak Output Current	I_{Opeak}	V_{IN} = 2.8 V	1.0	1.5	3.0	A
		V_{IN} = 3.3 V	1.0	1.7	3.0	
		V_{IN} = 16 V		1.1		
Temperature Coefficient of Output Voltage	$\Delta V_O / \Delta T$	0°C ≤ T_J ≤ 125°C, I_O = 5 mA		−0.4		mV/°C
ON Voltage	$V_{ON/OFF}$		2.0			V
OFF Voltage	$V_{ON/OFF}$				0.8	V
ON/OFF Pin Current	$I_{ON/OFF}$	V_{IN} = 2.8 V, $V_{ON/OFF}$ = 2.8 V			90	μA
		V_{IN} = 3.3 V, $V_{ON/OFF}$ = 3.3 V			110	
		V_{IN} = 5 V, $V_{ON/OFF}$ = 5 V			160	
Standby Current	$I_{BIAS\ (OFF)}$	$V_{ON/OFF}$ = 0 V			10	μA

Remark Values in parentheses are reference values obtained during product design.

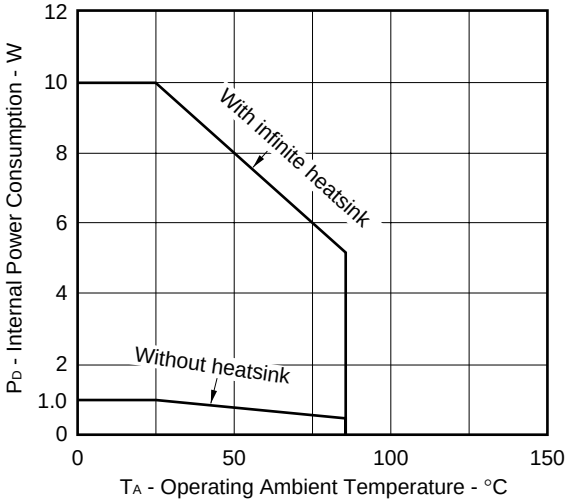
μPC3025 (T_J = 25°C, V_{IN} = 3.5 V, $V_{ON/OFF}$ = 3.5 V, I_O = 0.5 A, C_{IN} = 0.1 μF, C_{OUT} = 10 μF, unless otherwise specified)

Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Output Voltage	V_O		2.45	2.5	2.55	V
		0°C ≤ T_J ≤ 125°C, 3.5 V ≤ V_{IN} ≤ 5 V, 0 mA ≤ I_O ≤ 1 A	(2.375)		(2.575)	
Line Regulation	REG_{IN}	3.5 V ≤ V_{IN} ≤ 16 V		6	25	mV
Load Regulation	REG_L	0 A ≤ I_O ≤ 1 A		7	30	mV
Quiescent Current	I_{BIAS}	I_O = 0 A		2	4	mA
		I_O = 1 A		20	60	
Startup Quiescent Current	$I_{BIAS\ (s)}$	V_{IN} = 2.4 V, $V_{ON/OFF}$ = 2.0 V, I_O = 0 A		10	30	mA
		V_{IN} = 3.0 V, $V_{ON/OFF}$ = 2.0 V, I_O = 1 A			80	
Quiescent Current Change	ΔI_{BIAS}	0°C ≤ T_J ≤ 125°C, 3.5 V ≤ V_{IN} ≤ 16 V		2.9	20	mA
Output Noise Voltage	V_n	10 Hz ≤ f ≤ 100 kHz		40		$\mu V_{r.m.s.}$
Ripple Rejection	R•R	f = 120 Hz, 3.5 V ≤ V_{IN} ≤ 9 V	(45)	60		dB
Dropout Voltage	V_{DIF}	I_O = 0.5 A		0.25	0.5	V
		0°C ≤ T_J ≤ 125°C, I_O = 1 A		0.7		
Short Circuit Current	I_{Oshort}	V_{IN} = 3.5 V	1.2	1.7	3.0	A
		V_{IN} = 16 V		1.2		
Peak Output Current	I_{Opeak}	V_{IN} = 3.5 V	1.0	1.5	3.0	A
		V_{IN} = 5 V	1.0	2.1	3.0	
		V_{IN} = 16 V		1.1		
Temperature Coefficient of Output Voltage	$\Delta V_O / \Delta T$	0°C ≤ T_J ≤ 125°C, I_O = 5 mA		–0.5		mV/°C
ON Voltage	$V_{ON/OFF}$		2.0			V
OFF Voltage	$V_{ON/OFF}$				0.8	V
ON/OFF Pin Current	$I_{ON/OFF}$	V_{IN} = 3.5 V, $V_{ON/OFF}$ = 3.5 V			110	μA
		V_{IN} = 5 V, $V_{ON/OFF}$ = 5 V			160	
Standby Current	$I_{BIAS\ (OFF)}$	$V_{ON/OFF}$ = 0 V			10	μA

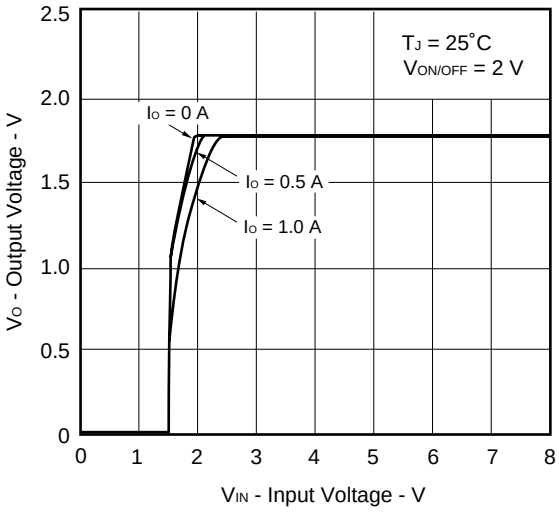
Remark Values in parentheses are reference values obtained during product design.

★ TYPICAL CHARACTERISTICS (Reference Values)

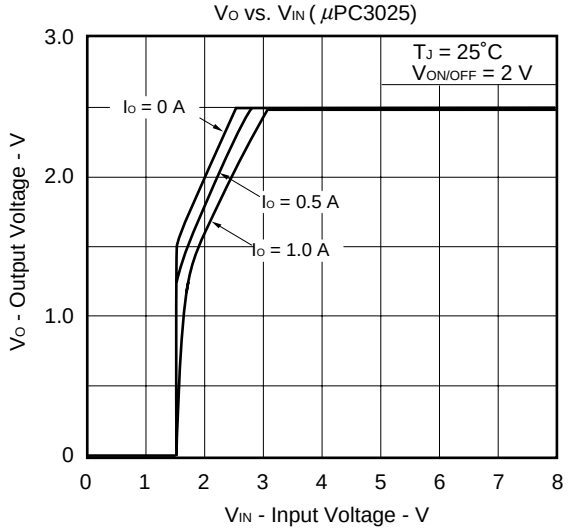
P_D vs. T_A



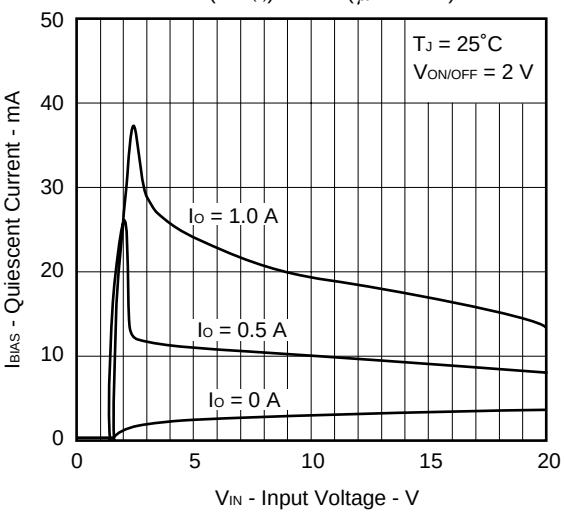
V_O vs. V_{IN} (μPC3018)



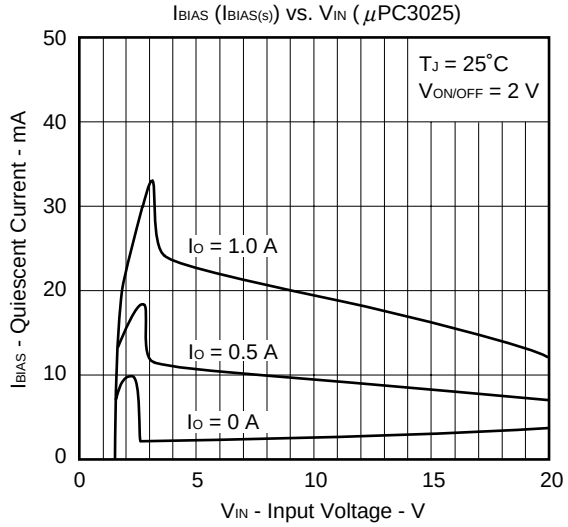
V_O vs. V_{IN} (μPC3025)



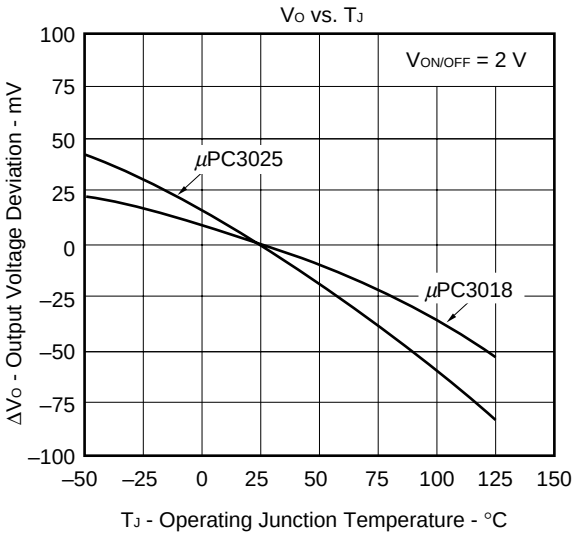
I_{BIAS} ($I_{BIAS(s)}$) vs. V_{IN} (μPC3018)



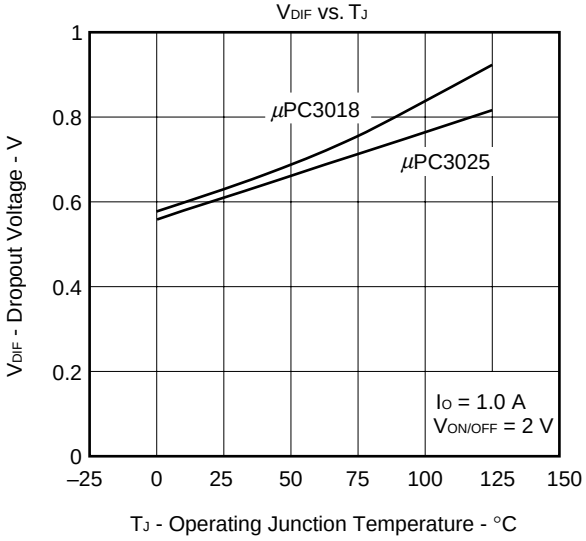
I_{BIAS} ($I_{BIAS(s)}$) vs. V_{IN} (μPC3025)



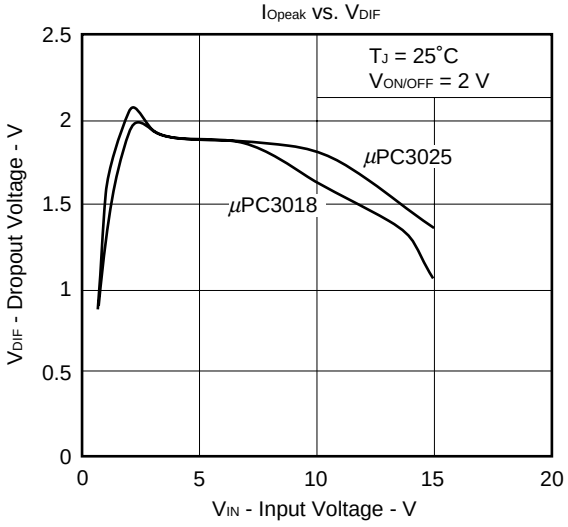
V_O vs. T_J



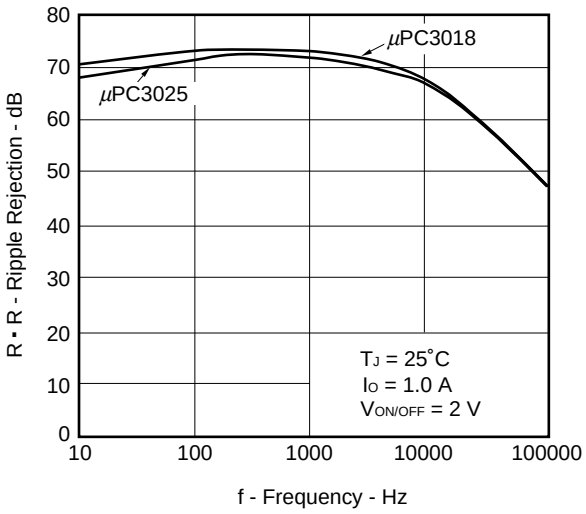
V_{DIF} vs. T_J



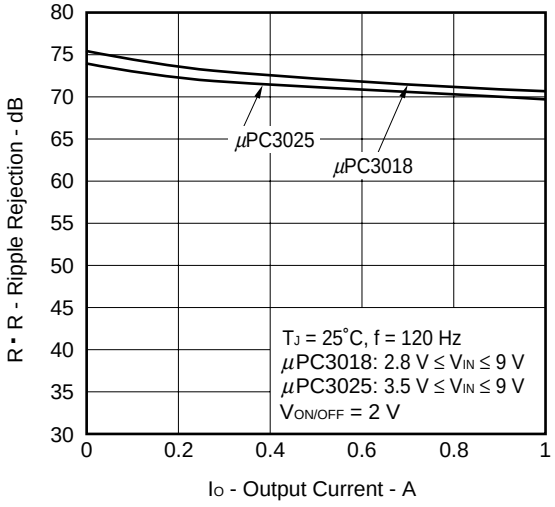
I_{Opeak} vs. V_{DIF}



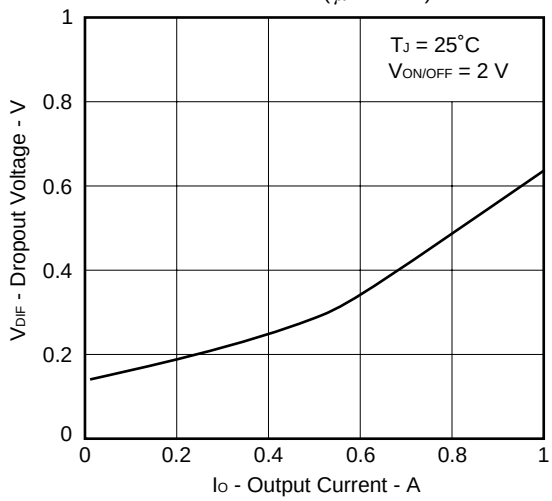
R ▪ R vs. f



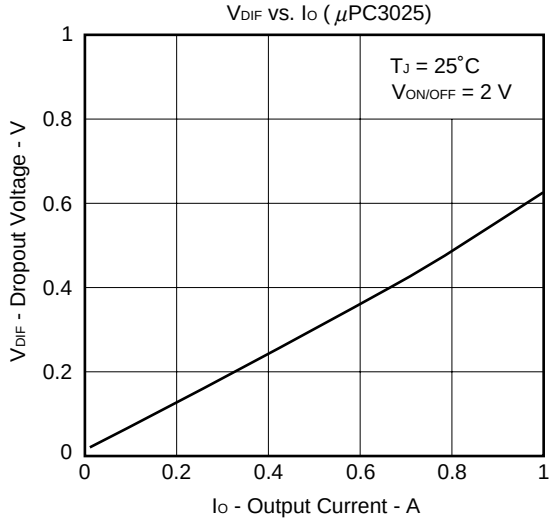
R ▪ R vs. I_O



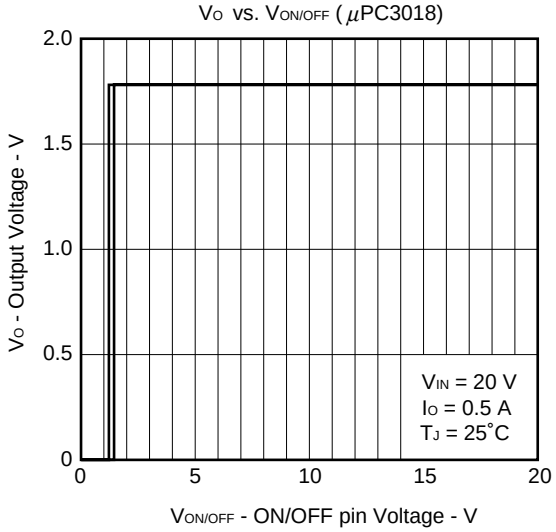
V_{DIF} vs. I_O (μPC3018)



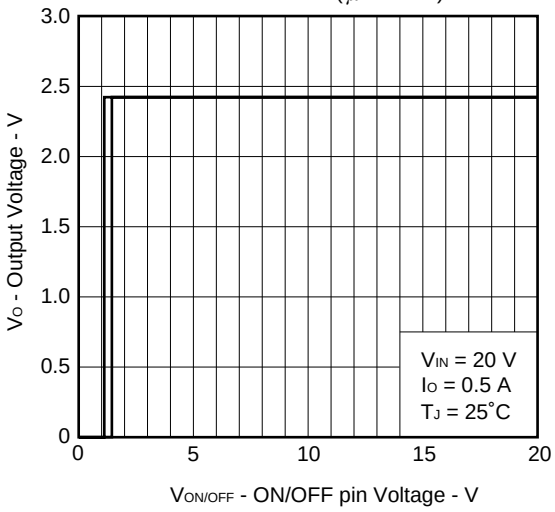
V_{DIF} vs. I_O (μPC3025)



V_O vs. $V_{ON/OFF}$ (μPC3018)

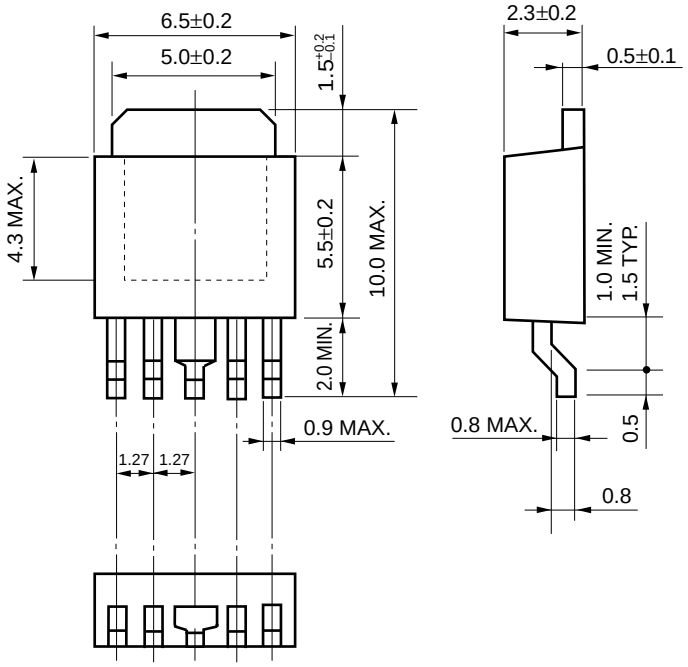


V_O vs. $V_{ON/OFF}$ (μPC3025)

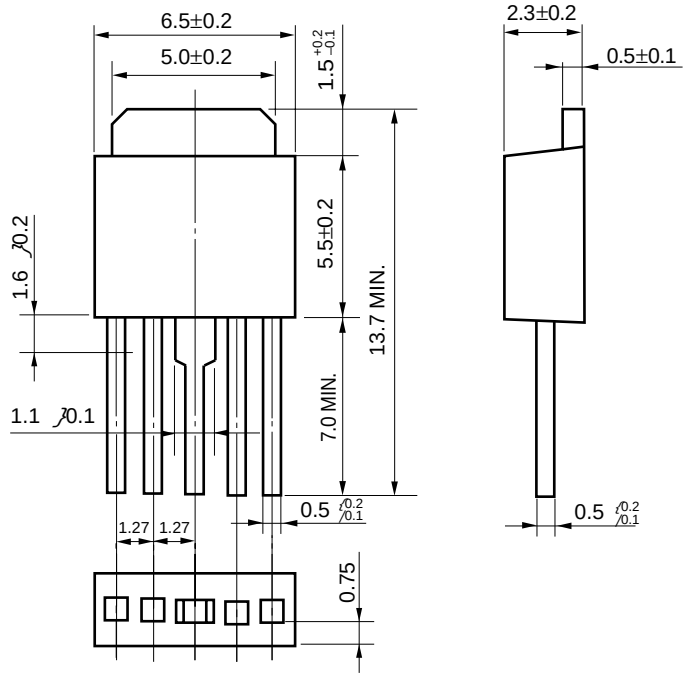


PACKAGE DRAWINGS

MP-3Z (5 pin) (Unit: mm)



MP-3 (5 pin) (Unit: mm)



RECOMMENDED SOLDERING CONDITIONS

The μPC3018, 3025 should be soldered and mounted under the following recommended conditions.

For the details of the recommended soldering conditions, refer to the document **Semiconductor Device Mounting Technology Manual (C10535E)**.

For soldering methods and conditions other than those recommended below, contact our sales representative.

Type of Surface Mount Device

μPC3018TJ, μPC3025TJ: MP-3Z (5 pin)

Process	Conditions	Symbol
Infrared Ray Reflow	Peak temperature: 235°C, Reflow time: 30 seconds or less (at 210°C or higher), Maximum number of reflow processes: 3 times or less.	IR35-00-3
Vapor Phase Soldering	Peak temperature: 215°C, Reflow time: 40 seconds or less (at 200°C or higher), Maximum number of reflow processes: 3 times or less.	VP15-00-3
Wave Soldering	Solder temperature: 260°C or below, Flow time: 10 seconds or less, Maximum number of flow processes: 1 time, Pre-heating temperature: 120°C MAX. (Package surface temperature).	WS60-00-1
Partial Heating Method	Pin temperature: 300°C or below, Heat time: 3 seconds or less (Per each side of the device).	–

Caution Apply only one kind of soldering condition to a device, except for "partial heating method", or the device will be damaged by heat stress.

Remark It is recommended to use a rosin-type flux with a low chlorine element (chlorine: 0.2 Wt% or less).

Type of Through-hole Device

μPC3018HB, μPC3025HB: MP-3 (5 pin)

Process	Conditions
Wave Soldering (only to leads)	Solder temperature: 260°C or below, Flow time: 10 seconds or less
Partial Heating Method	Pin temperature: 300°C or below, Heat time: 3 seconds or less (Per each pin).

Caution For through-hole device, the wave soldering process must be applied only to leads, and make sure that the package body does not get jet soldered.

CAUTION ON USE

If the μPC3018 and μPC3025 Series are used with an input voltage that is lower than the recommended operating conditions, a large circuit current flows because the transistor in the output stage is saturated. The specification of this characteristic is the circuit operating current at startup, $I_{BIAS\ (S)}$. In this product, the circuit current flowing at startup is limited by an on-chip inrush current protection circuit, but a circuit current of up to 80 mA may still flow. The power supply on the input side must therefore have sufficient capacitance to handle this circuit current at startup.

REFERENCE DOCUMENTS

Document Name	Document No.
Usage of Three-Terminal Regulators User's Manual	G12702E
Voltage Regulator of SMD Information	G11872E
Semiconductor Device Mounting Technology Manual Information	C10535E
SEMICONDUCTOR SELECTION GUIDE - Products and Packages-	X13769X

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